BGA Heat Sink - High Performance ASIC Cooling





ATS Part#: ATS-56004-C4-R0

Description: 40.00 x 30.00 x 5.00 mm BGA Heat Sink - High Performance ASIC Cooling

Heat Sink Type: ASIC Cooling
Heat Sink Attachment: Thermal Tape

Equivalent Part Number: N/A

Features & Benefits

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- · Designed specifically for ASIC package and their unique cooling requirements

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	7.9 °C/W	6.6 °C/W	5.4 °C/W	4.7 °C/W	4 °C/W	3.6 °C/W	3.3 °C/W
	Ducted Flow	4.8	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
	40.00 mm	30.00 mm	5.00 mm	38.1 mm	NO TIM	BLACK-ANODIZED
*Image above is for illustration purpose only.	 Dimension Thermal application ATS reserve performa ATS cert 	erves the right to up	theight from the boare provided for reference date or change its provided ink assembly is Rol	rence only. Actual poroducts without not	performance	may vary by



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